TPS53129EVM-621 Evaluation Module

The TPS53129EVM-621 Evaluation Module presents an easy-to-use reference design for a common dual-output power supply using the TPS53129 controller in cost-sensitive applications.

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1 Introduction

1.1 Description

The TPS53129EVM-621 evaluation board provides the user with a convenient way to evaluate the TPS53129 Dual D-CAP2™ Mode Control Step-Down Controller in a realistic cost-sensitive application. Providing both a low core-type 1.05-V and I/O type 1.8-V output at up to 4 A from a loosely regulated 12-V (8-V to 22-V) source, the TPS53129EVM-621 includes switches and test points to assist users in evaluating the performance of the TPS53129 controller in their application.

1.2 Application

- Digital television
- Set-top box
- DSL and cable modems
- Cost-sensitive digital consumer products

1.3 Features

- 8-V to 22-V input
- 1.05-V and 1.8-V output
- Up to 4 A per channel output
- 700-kHz pseudo-fixed frequency D-CAP2™ mode control
- Independent enable switches for power-on/power-off testing

2 Electrical Performance Specifications

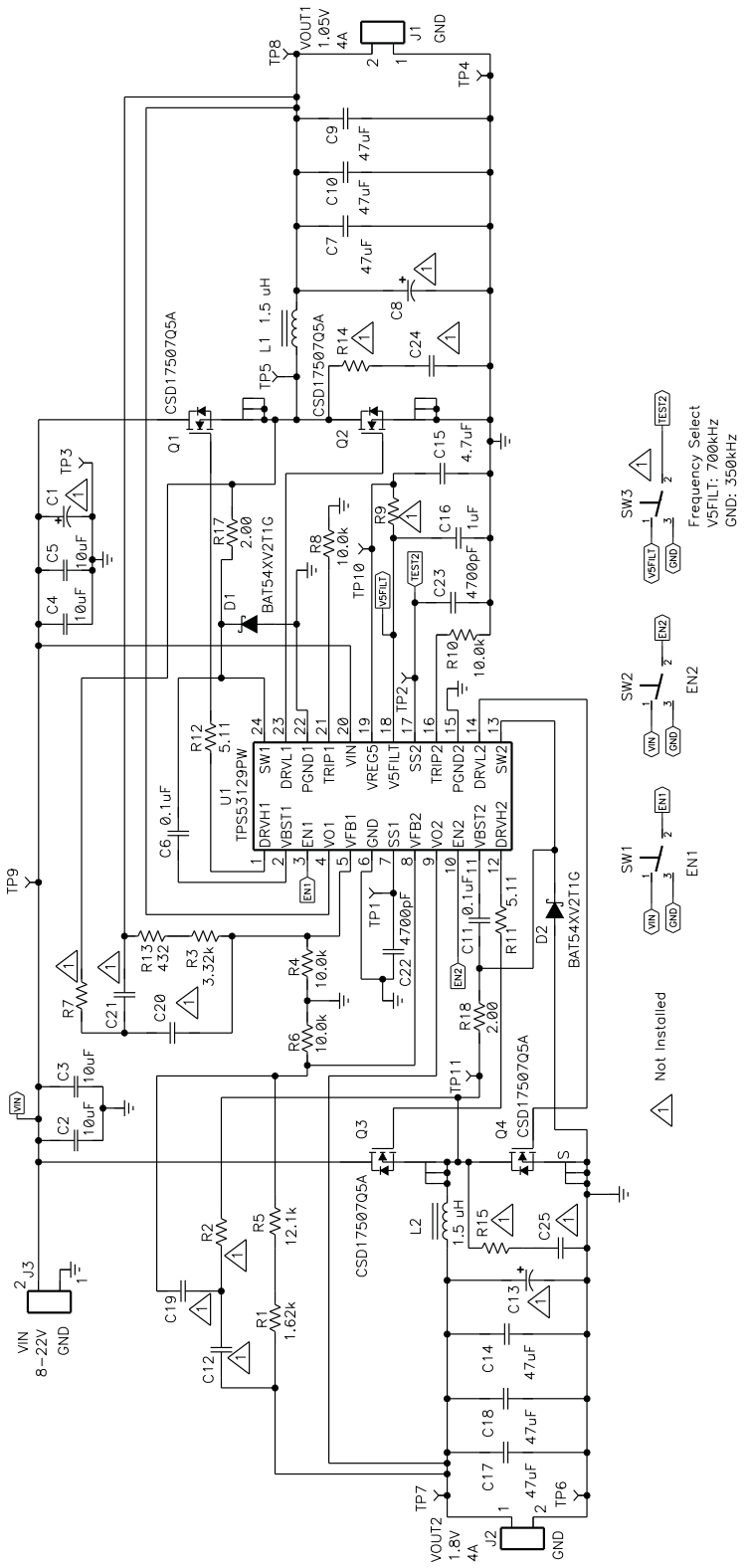
Table 1. TPS53129EVM-621 Electrical and Performance Specifications

Parameter		Notes and Conditions	MIN	TYP	MAX	UNIT
INPUT CHARACTERISTICS						
V_{IN}	Input Voltage		8	12	22	V
I_{IN}	Input Current	V_{IN} = 12 V, I_{OUT1} = 4 A, I_{OUT2} = 4 A	–	1.2	1.5	A
	No-Load Input Current	V_{IN} = 12 V, I_{OUT} = 0 A	–	20	–	mA
V_{IN_UVLO}	Input UVLO	I_{OUT} = 4 A	4.0	4.2	4.5	V
OUTPUT CHARACTERISTICS						
V_{OUT1}	Output Voltage 1	V_{IN} = 12 V, I_{OUT1} = 2 A	–	1.05	–	V
	Line Regulation	V_{IN} = 8 V to 22 V	–	–	1%	
	Load Regulation	I_{OUT1} = 0 A to 4 A	–	–	1%	
V_{OUT1_rip}	Output Voltage Ripple	V_{IN} = 12 V, I_{OUT2} = 4 A	–	-	30	mVpp
I_{OUT1}	Output Current 1	V_{IN} = 8 V to 22 V	0		4	A
V_{OUT2}	Output Voltage 2	V_{IN} = 12 V, I_{OUT2} = 2 A	–	1.80	–	V
	Line Regulation	V_{IN} = 8 V to 22 V	–	–	1%	
	Load Regulation	I_{OUT2} = 0 A to 4 A	–	–	1%	
V_{OUT2_rip}	Output Voltage Ripple	V_{IN} = 12 V, I_{OUT2} = 4 A	–	–	30	mVpp
I_{OUT2}	Output Current 2	V_{IN} = 8 V to 22 V	0		4	A
SYSTEMS CHARACTERISTICS						
F_{SW}	Switching Frequency		350	700	800	kHz
ηpk1	Peak Efficiency of Output 1	V_{IN} = 12 V	–	85%	–	
η1	Full-Load Efficiency of Output 1	V_{IN} = 12 V, I_{OUT1} = 4 A	–	84%	–	
ηpk2	Peak Efficiency of Output 2	V_{IN} = 12 V	–	89%	–	
η2	Full-Load Efficiency of Output 2	V_{IN} = 12 V, I_{OUT2} = 4 A	–	88%	–	

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3 Schematics



NOTE: For Reference Only, See Table 3 for Specific Values.

Figure 1. TPS53129EVM-621 Schematic

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4 Connector and Test Point Descriptions

4.1 Enable Switches – SW1 and SW2

TPS53129EVM-621 includes independent enable switches for each of the two outputs. When the switch is in the DIS position, the channel is disabled and discharged per the TPS53129's internal discharge characteristics.

To enable V_{OUT1}, place SW1 in the EN position. To enable V_{OUT2}, place SW2 in the EN position.

4.2 Switching Frequency Select Switch – SW3

TPS53129EVM-621 does not populate SW3. When using TPS53129EVM-621 to evaluate the TPS53126 controller in the TSSOP package, SW3 can be populated to allow selection of the TPS53126 switching frequency between 350 kHz and 700 kHz.

4.3 Test Point Descriptions

Table 2 lists the test points, their labels, uses, and where additional information is located.

Table 2. TPS53129EVM-621 Test Points Description

Test Point	Label	Use	Section
TP1	SS1	Monitor Channel-1 Soft-Start Voltage	Section 4.3.4
TP2	SS2	Monitor Channel-2 Soft-Start Voltage	Section 4.3.4
TP3	GND	Ground for Input Voltage	Section 4.3.1
TP4	GND	Ground for Channel-1 Output Voltage	Section 4.3.2
TP5	SW1	Monitor Switching Node for Channel 1	Section 4.3.5
TP6	GND	Ground for Channel-2 Output Voltage	Section 4.3.3
TP7	VOUT2	Monitor Output Voltage for Channel 2	Section 4.3.3
TP8	VOUT1	Monitor Output Voltage for Channel 1	Section 4.3.2
TP9	VIN	Monitor Input Voltage	Section 4.3.1
TP10	VREG5	Monitor Output of VREG5 Regulator	Section 4.3.6
TP11	SW2	Monitor Switching Node for Channel 2	Section 4.3.5

4.3.1 Input Voltage Monitoring – TP3 and TP9

TPS53129EVM-621 provides two test points for measuring the voltage applied to the module. This allows the user to measure the actual module voltage without losses from input cables and connectors. Measure all input voltage between TP9 and TP3. To use TP9 and TP3, connect a voltmeter positive terminal to TP9 and negative terminal to TP3.

4.3.2 Channel-1 Output Voltage Monitoring – TP4 and TP8

TPS53129EVM-621 provides two test points for measuring the voltage generated at the VOUT1 output by the module. This allows the user to measure the actual output voltage without losses from output cables and connectors. Measure all dc output voltage measurements between TP8 and TP4. To use TP8 and TP4, connect a voltmeter positive terminal to TP8 and negative terminal to TP4.

For output ripple measurements, TP8 and TP4 allow a user to limit the ground loop area by using the tip and barrel measurement technique shown in Figure 2.

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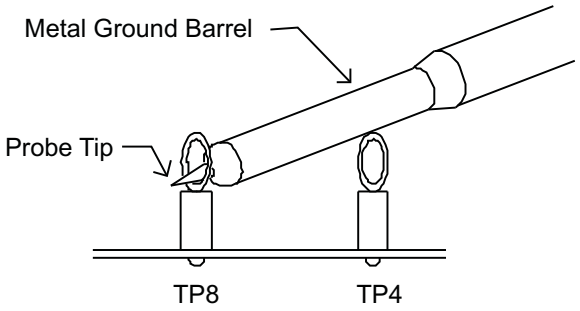


Figure 2. Tip and Barrel Measurement for Output Voltage Ripple

4.3.3 Channel-2 Output Voltage Monitoring – TP6 and TP7

TPS53129EVM-621 provides two test points for measuring the voltage generated at the VOUT2 output by the module. This allows the user to measure the actual output voltage without losses from output cables and connectors. Measure all dc output voltage between TP7 and TP6. To use TP7 and TP6, connect a voltmeter positive terminal to TP7 and negative terminal to TP6.

For output ripple measurements, TP7 and TP6 allow a user to limit the ground loop area by using the tip and barrel measurement technique shown in Figure 2.

4.3.4 Soft-Start Voltage Monitoring – TP1, TP2, and TP3

TPS53129EVM-621 provides two test points for measuring the soft-start ramp voltages. TP1 monitors the soft-start ramp of Channel 1. TP2 monitors the soft-start ramp of Channel 2. To use TP1 or TP2, connect an oscilloscope probe between TP1 or TP2 and TP3.

4.3.5 Switching Node Monitoring – TP3, TP5, and TP11

TPS53129EVM-621 provides two test points for measuring the switching node waveform voltages. TP5 monitors the switching node of Channel 1. TP2 monitors the switching node of Channel 2. To use TP5 or TP11, connect an oscilloscope probe between TP5 or TP11 and TP3.

4.3.6 5-V Regulator Output Monitoring – TP3 and TP10

TPS53129EVM-621 provides a test point for measuring the output of the internal 5-V regulator. TP10 monitors the output voltage of the internal 5-V regulator. To use TP10, connect a voltmeter positive terminal to TP10 and negative terminal to TP3.

5 Test Setup

5.1 Equipment

5.1.1 Voltage Source

Use an input voltage source (V_{IN}) of 0-V to 25-V variable dc source capable of supplying 2 Adc minimum.

5.1.2 Meters

A1: 0-Adc to 5-Adc, ammeter

V1: V_{IN}, 0-V to 25-V voltmeter

V2: V_{OUT1}, 0-V to 2-V voltmeter

V3: V_{OUT2}, 0-V to 2-V voltmeter

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5.1.3 Loads

LOAD1: One output load is an electronic load set for constant-current mode capable of 0 Adc to 4 Adc at 1.05 Vdc.

LOAD2: The other output load is an electronic load set for constant-current mode capable of 0 Adc to 4 Adc at 1.8 Vdc.

5.1.4 Oscilloscope and Probe

The oscilloscope, analog or digital, must be set for ac-coupled measurement with 20-MHz bandwidth limiting. Use 20-mV/division vertical resolution, 1-µs/division horizontal resolution for output ripple voltage test.

Oscilloscope probes with exposed conductive ground barrels are recommended.

5.1.5 Recommended Wire Gauge

V_{IN} to J3 – The connection between the source voltage VIN and J1 of TPS53129EVM-621 can carry as much as 2 Adc. The minimum recommended wire size is AWG 16 with the total length of wire less than 2 feet (1-foot input, 1-foot return).

J1 to LOAD1 and J2 to LOAD2 – The connection between J1 and LOAD1, and J2 and LOAD2 of TPS53129EVM-621 can carry as much as 4 Adc each. The minimum recommended wire size is AWG 14 with the total length of wire less than 2 feet (1-foot input, 1-foot return).

5.1.6 Other Test Equipment

FAN – The TPS53129EVM-621 evaluation module includes components that can become hot to the touch. Because this EVM is not enclosed to allow probing of circuit nodes, a small fan capable of 200-400 lfm is recommended to reduce component temperatures when operating.

5.2 Recommended Setup

Figure 3 shows the recommended test setup to evaluate the TPS53129EVM-621. Working at an ESD workstation, ensure that any wrist straps, bootstraps, or mats are connected referencing the user to earth ground before power is applied to the EVM. An electrostatic smock and safety glasses also are recommended.

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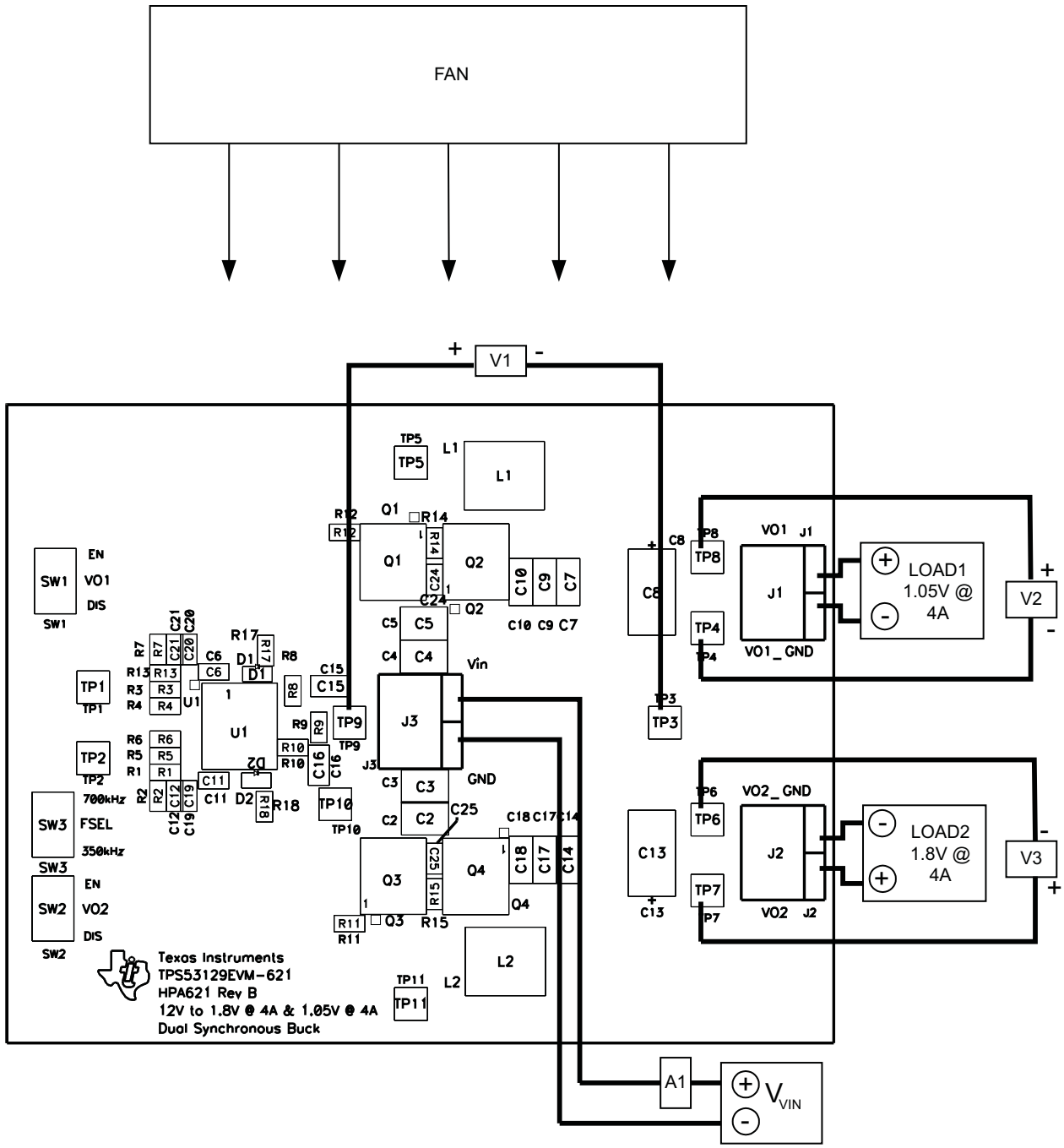


Figure 3. TPS53129EVM-621 Recommended Test Setup

6 Test Procedure

6.1 Start-Up Procedure

1. Prior to connecting the dc input source VIN, it is advisable to limit the source current from V_{IN} to 2 Adc maximum. Ensure that V_{IN} is initially set to 0 V.
2. Ensure that LOAD1 and LOAD2 are set to constant-current mode to sink 0 A before V_{IN} is applied.
3. Verify that SW1 and SW2 are in the desired position.
4. Place a fan as shown in Figure 3 and turn on, making sure that air is flowing across the EVM.

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5. Increase V_{IN} from 0 Vdc to 12 Vdc.

6.2 Line/Load Regulation and Efficiency Measurement Procedure

1. Set up the TPS53129EVM-621 per Section 5.2.
2. Start up the TPS53129EVM-621 per Section 6.1.
3. Adjust V_{IN} to desired value between 8 Vdc and 22 Vdc.
4. Adjust LOAD1/LOAD2 to desired load between 0 Adc and 4 Adc.
5. Read input voltage, output voltage, and input current from V1, V2/V3, and A1, respectively.
6. Shut down the TPS53129EVM-621 per Section 6.4.

6.3 Output Ripple Voltage Measurement Procedure

1. Set up the TPS53129EVM-621 per Section 5.2.
2. Start up the TPS53129EVM-621 per Section 6.1.
3. Adjust V_{IN} to desired value between 8 Vdc and 22 Vdc.
4. Adjust LOAD1/LOAD2 to desired load between 0 Adc and 4 Adc.
5. Connect the oscilloscope probe to TP8 and TP4 for V_{OUT1}, or TP7 and TP6 for V_{OUT2} as shown in Figure 2.
6. Measure output ripple.
7. Shut down the TPS53129EVM-621 per Section 6.4.

6.4 Shutdown Procedure

1. Set SW1 to DIS.
2. Set SW2 to DIS.
3. Decrease LOAD1 to 0 A, and shut down LOAD1.
4. Decrease LOAD2 to 0 A, and shut down LOAD2.
5. Decrease V_{IN} to 0 V, and shut down V_{IN}.
6. Shut down the fan.

7 Performance Data and Typical Characteristic Curves

Figure 4 through Figure 11 present typical performance curves for the TPS53129EVM-621. Because actual performance data can be affected by measurement techniques and environmental variables, these curves are presented for reference and may differ from actual field measurements.

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7.1 Efficiency

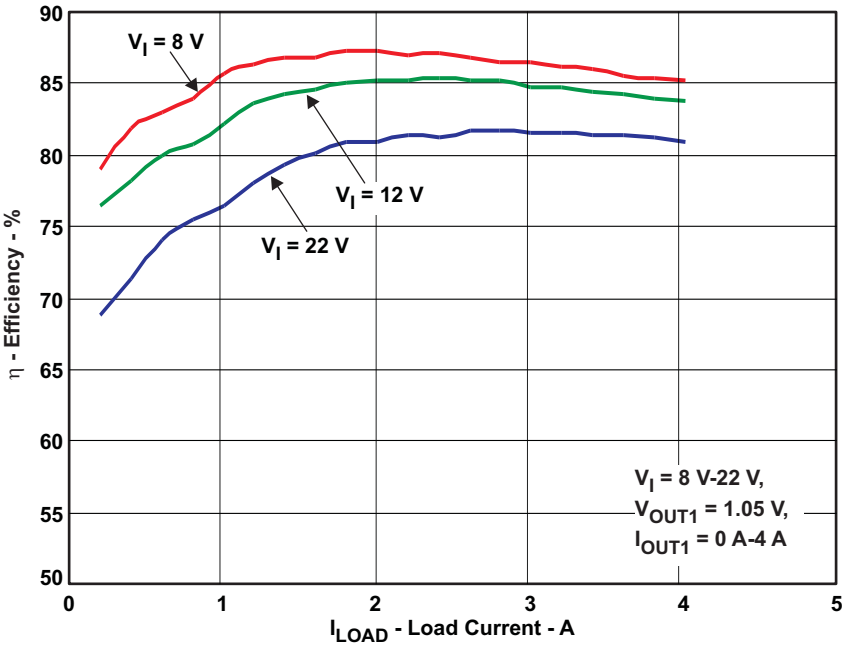


Figure 4. Efficiency vs Load

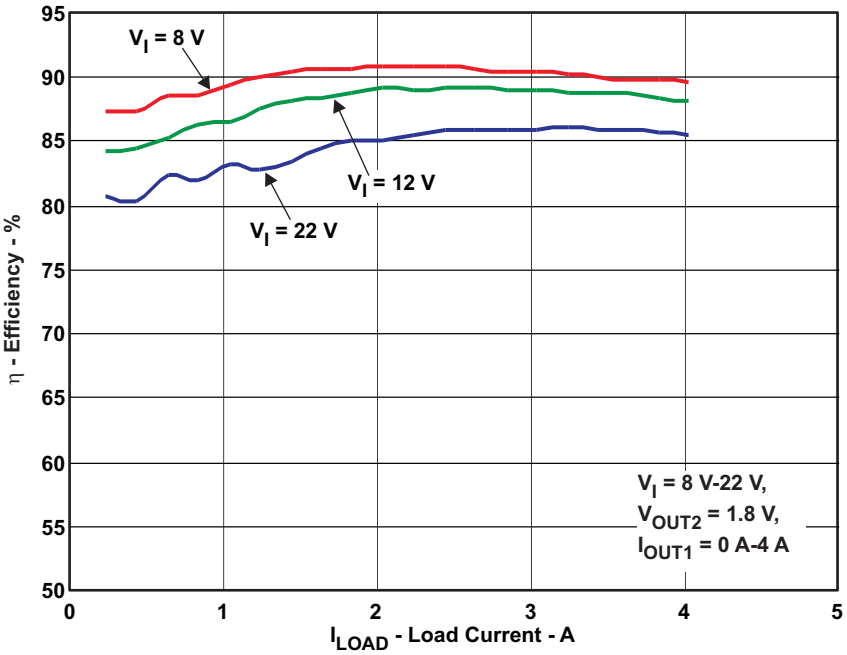


Figure 5. Efficiency vs Load

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7.2 Line and Load Regulation

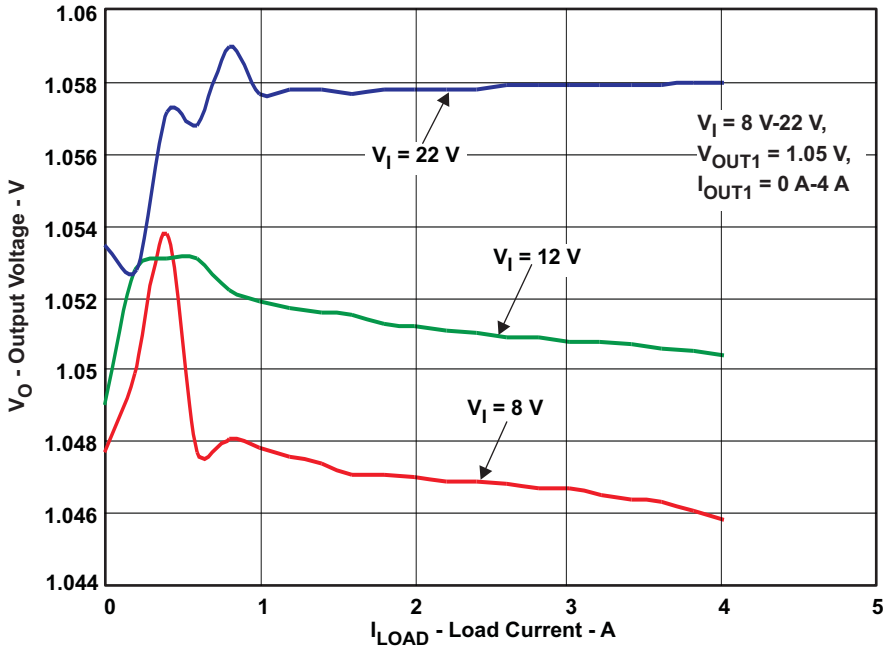


Figure 6. Output Voltage vs Load

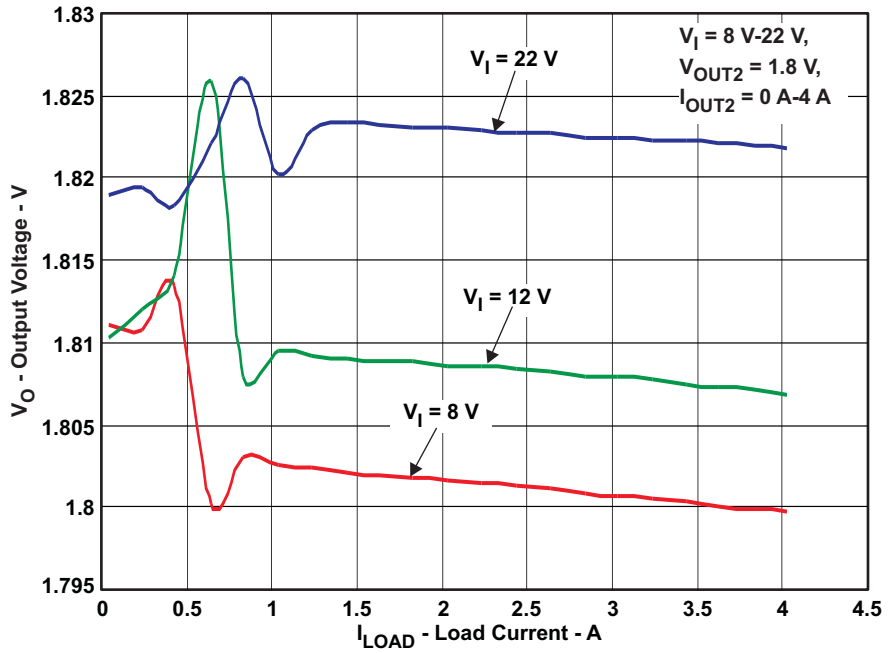


Figure 7. Output Voltage vs Load

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7.3 Output Voltage Ripple

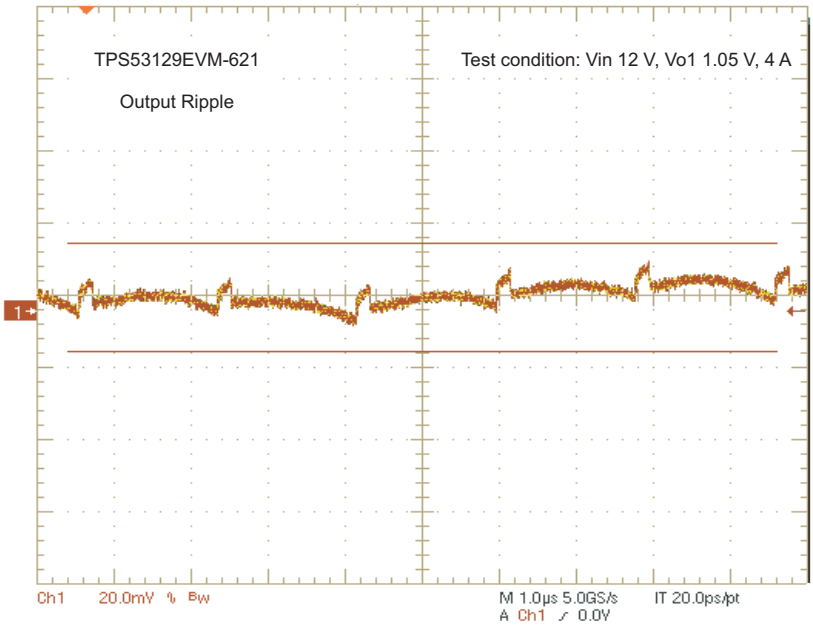


Figure 8. Output Voltage Ripple

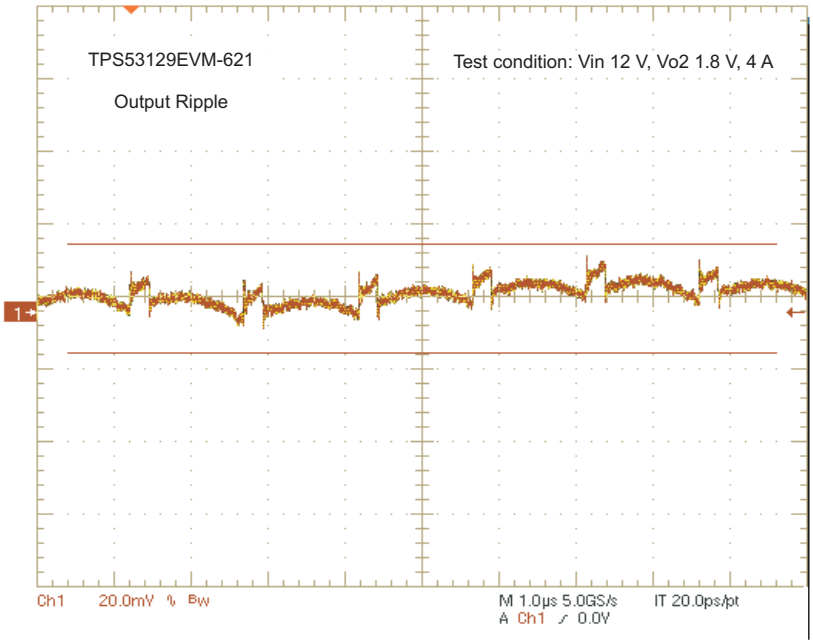


Figure 9. Output Voltage Ripple

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7.4 Switch Node Waveforms

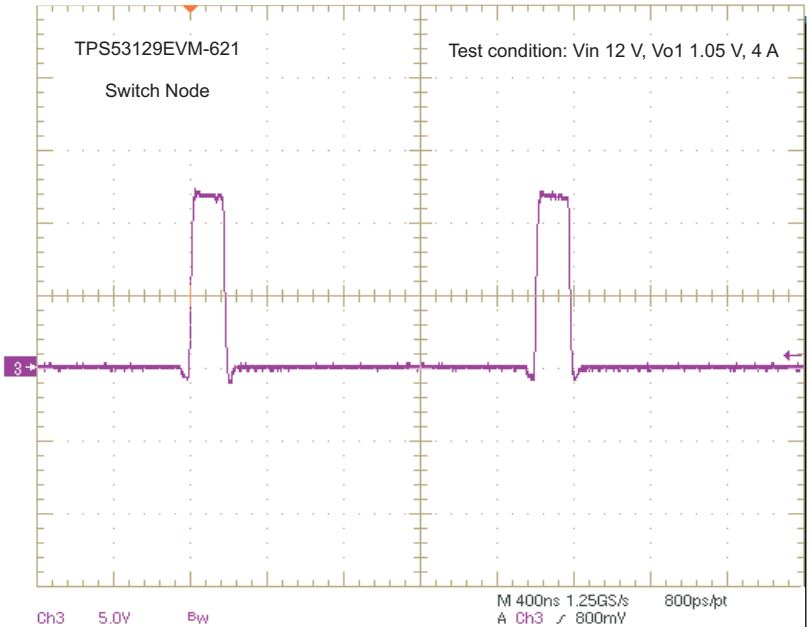


Figure 10. Switching Waveform

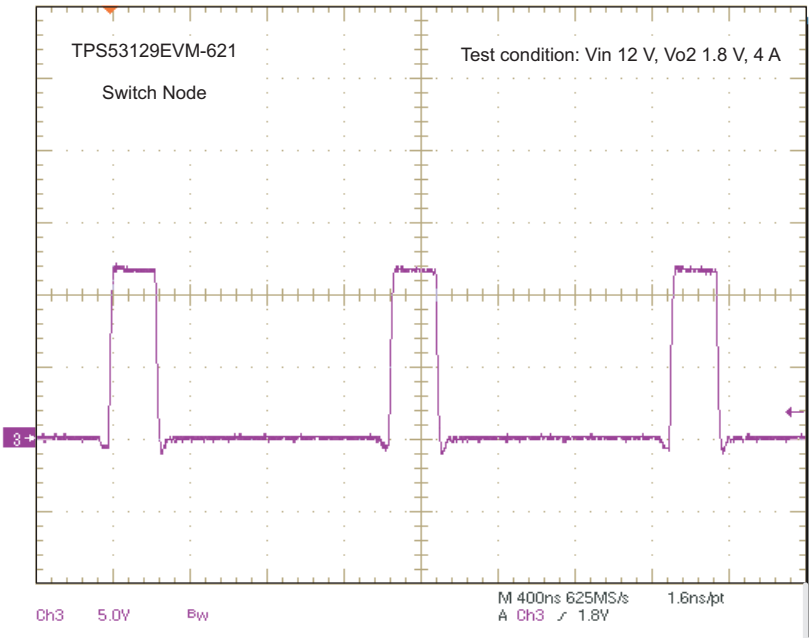


Figure 11. Switching Waveform

8 EVM Assembly Drawings and Layout

The following figures (Figure 12 through Figure 17) show the design of the TPS53129EVM-621 printed-circuit board (PCB). The EVM has been designed using a 4-layer, 2-oz copper-clad circuit board of 3.5 inch by 2.7 inch to allow the user to easily view, probe, and evaluate the TPS53129 control integrated circuit in a practical application. Moving components to both sides of the PCB or using additional internal layers can offer additional size reduction for space-constrained systems.

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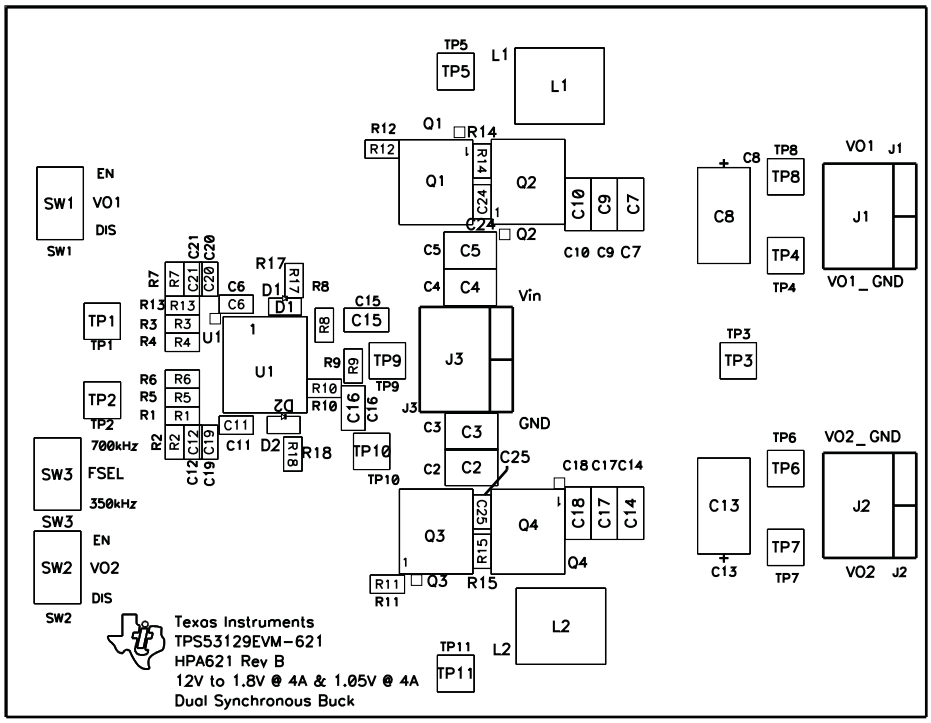


Figure 12. Top Assembly

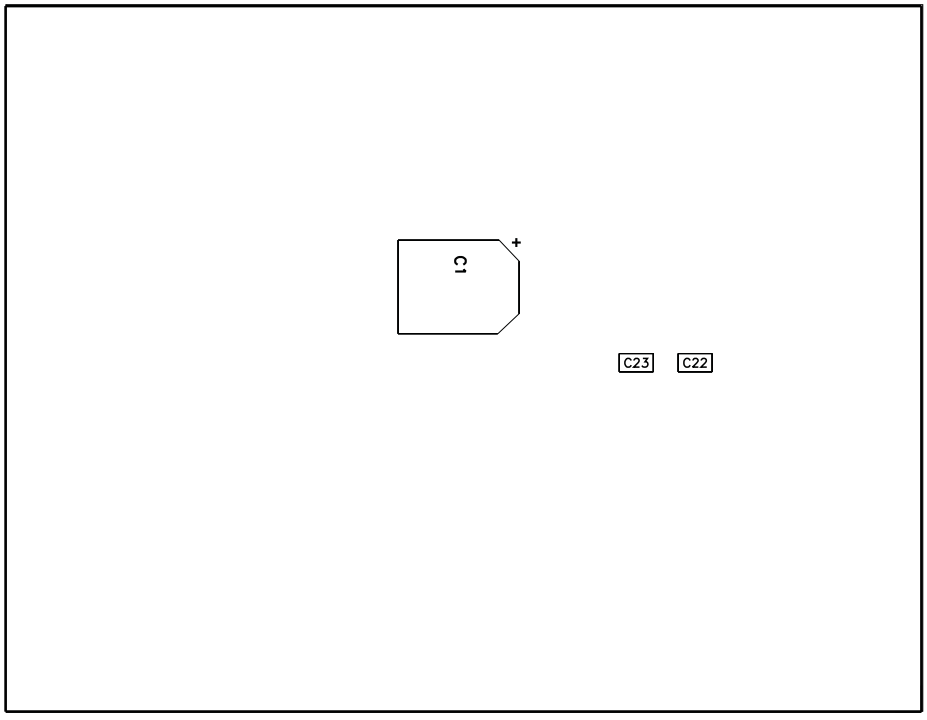


Figure 13. Bottom Assembly

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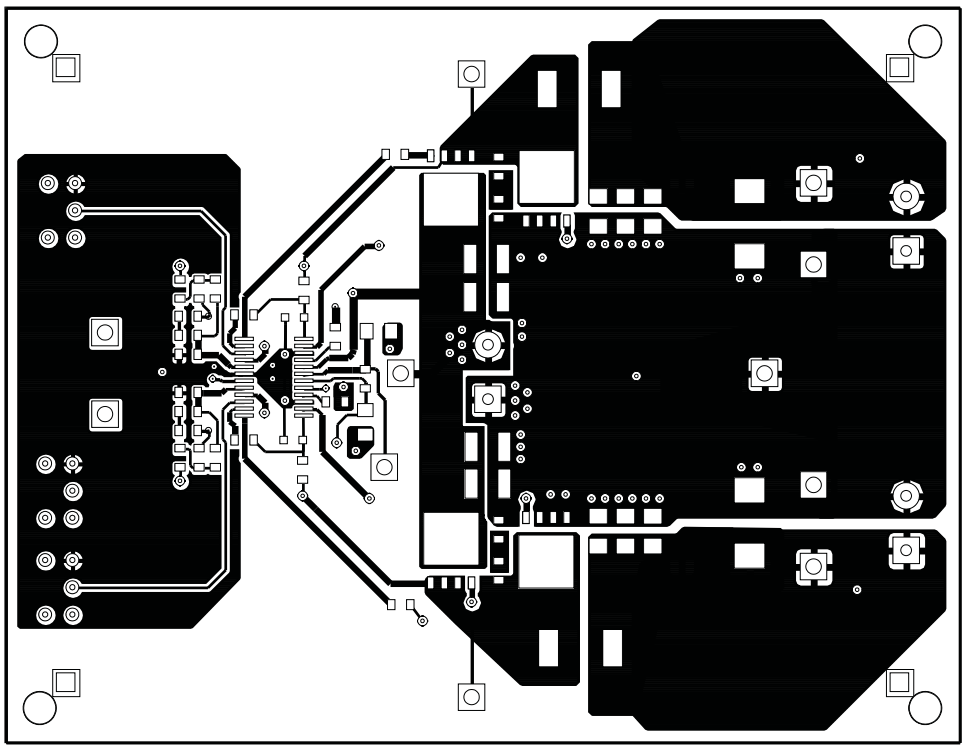


Figure 14. Top Layer

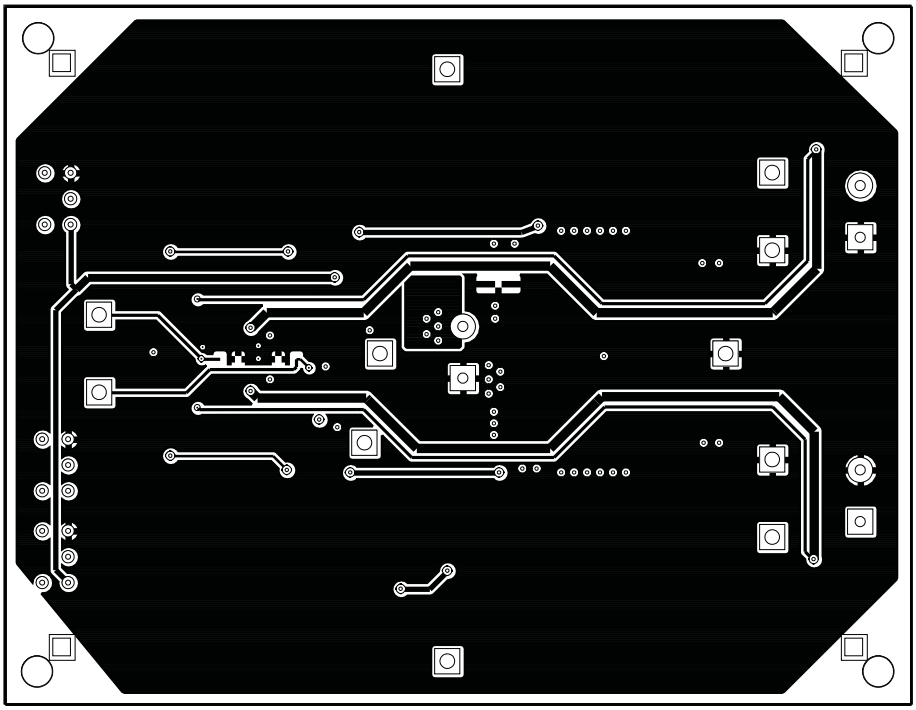


Figure 15. Bottom Layer

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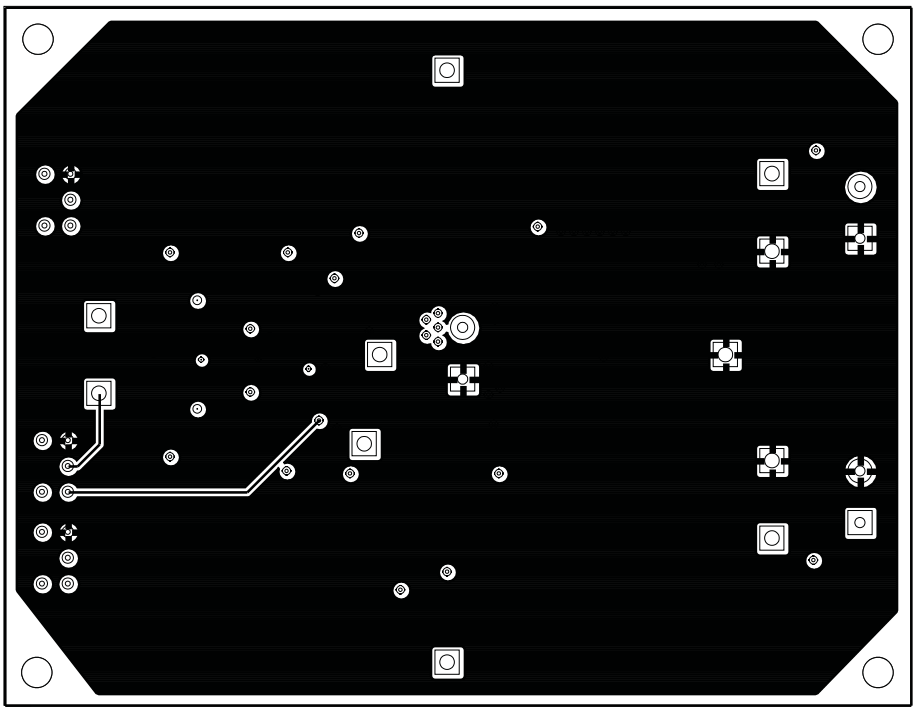


Figure 16. Internal Layer 1

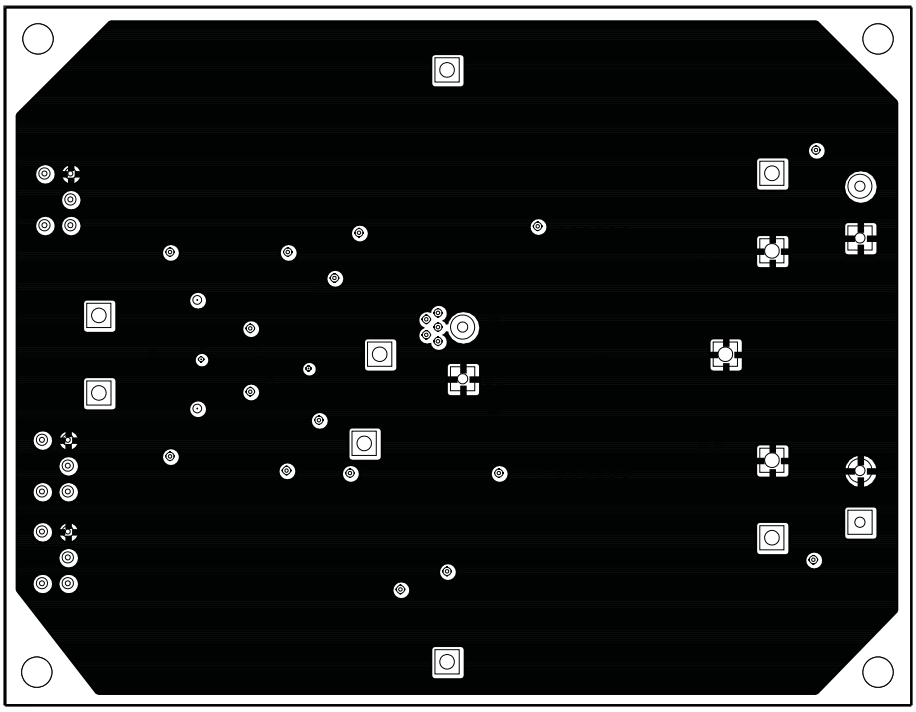


Figure 17. Internal Layer 2

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9 Bill of Materials

Table 3 contains the bill of materials for the TPS53129EVM-621. The reference designators refer to the schematic in Figure 1 and assembly locations in Figure 12 and Figure 13. Components with a quantity of 0 listed are not populated on the PCB but are provided for reference.

Table 3. TPS53129EVM-621 Bill of Materials

Qty	RefDes	Value	Description	Size	Part Number	MFR
0	C1		Capacitor, Aluminum, 25V, 20%	0.328 x 0.390 inch	Std	Std
0	C12, C19, C20, C21		Capacitor, Ceramic	0603	Std	Std
1	C15	4.7µF	Capacitor, Ceramic, 10V, X5R, 20%	0805	Std	Std
1	C16	1µF	Capacitor, Ceramic, 16V, X5R, 20%	0805	Std	Std
4	C2, C3, C4, C5	10µF	Capacitor, Ceramic, 25V, X5R, 20%	1210	Std	Std
2	C22, C23	4700pF	Capacitor, Ceramic, Low Inductance, 16V, X7R, 20%	0603	Std	Std
0	C24, C25		Capacitor, Ceramic, 25V, X7R, 20%	0603	Std	Std
2	C6, C11	0.1µF	Capacitor, Ceramic, 50V, X5R, 10%	0603	Std	Std
6	C7, C9, C10, C14, C17, C18	47µF	Capacitor, Ceramic, 6.3V, X5R, 20%	1206	Std	Std
0	C8, C13	330µF	Capacitor, PXE, 4.0V, 15 mΩ, 20%	7343 (D)	APXE4R0ARA331MF61G	NIPPON CHEMI-CON
2	D1, D2	BAT54XV2T1G	Diode, Schottky, 200 mA, 30 V	SOD523	BAT54XV2T1G	On Semi
3	J1, J2, J3	ED120/2DS	Terminal Block, 2-pin, 15-A, 5.1mm	0.40 x 0.35 inch	ED120/2DS	OST
2	L1, L2	1.5µH	Inductor, SMT, 11A, 9.7 mΩ	0.256 x 0.280 inch	SPM6530T-1R5M100	TDK
4	Q1, Q2, Q3, Q4	CSD17507Q5A	MOSFET, N-Chan, 30V, 65A, 11.8 mΩ	QFN-8 POWER	CSD17507Q5A	TI
1	R1	1.62k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
4	R10, R4, R6, R8	10.0k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
2	R11, R12	5.11	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R13	432	Resistor, Chip, 1/16W, 1%	0603	Std	Std
0	R14, R15		Resistor, Chip, 1/8W, 5%	0603	Std	Std
2	R17, R18	2.00	Resistor, Chip, 1/16W, 1%	0603	Std	Std
0	R2, R7, R9		Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R3	3.32k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R5	12.1k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
2	SW1, SW2	G12AP-RO	Switch, ON-ON Mini Toggle	0.28 x 0.18"	G12AP-RO	Nikkai
0	SW3	G12AP-RO	Switch, ON-ON Mini Toggle	0.28 x 0.18"	G12AP-RO	Nikkai
4	TP1, TP2, TP5, TP11	5012	Test Point, White, Thru Hole	0.125 x 0.125 inch	5012	Keystone
1	TP10	5013	Test Point, Orange, Thru Hole	0.125 x 0.125 inch	5013	Keystone
3	TP3, TP4, TP6	5011	Test Point, Black, Thru Hole	0.125 x 0.125 inch	5011	Keystone
2	TP7, TP8	5014	Test Point, Yellow, Thru Hole	0.125 x 0.125 inch	5014	Keystone
1	TP9	5010	Test Point, Red, Thru Hole	0.125 x 0.125 inch	5010	Keystone
1	U1	TPS53129PW	IC, Dual Synchronous Step-Down Controller For Low-Voltage Power Rails	TSSOP	TPS53129PW	TI
1	--		PCB, 2.70" x 3.50" x 0.063" FR-4	2.7" x 3.5"	HPA621	Any

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EVM Warnings and Restrictions

It is important to operate this EVM within the input voltage range of 8 V to 22 V and the output voltage range of 1.03 V to 1.90 V .

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 40° C. The EVM is designed to operate properly with certain components above 40° C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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